

SPECIFICATION

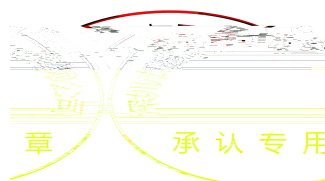
产品规格书

REFOND P/N 产品型号

RF-WNB170DS-DD

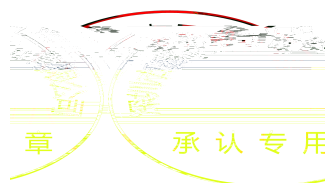
☐ R&D 研发

☒ Mass Product 量产供货



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1.4 Package Dimension 封装尺寸

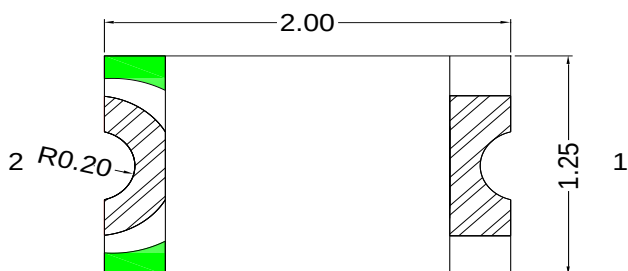


Fig.1-1 Top view 正面视图

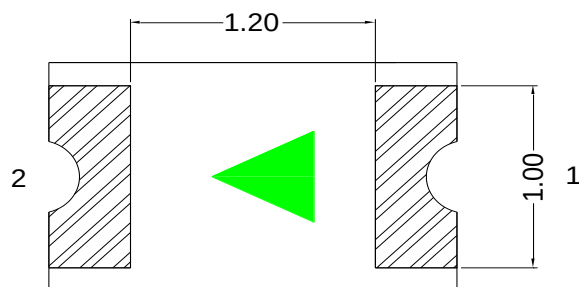


Fig.1-2 Bottom view 背面视图

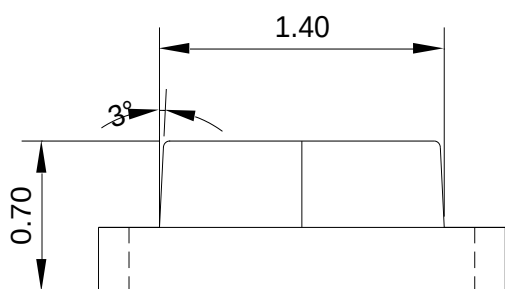


Fig.1-3 Side view 侧面视图

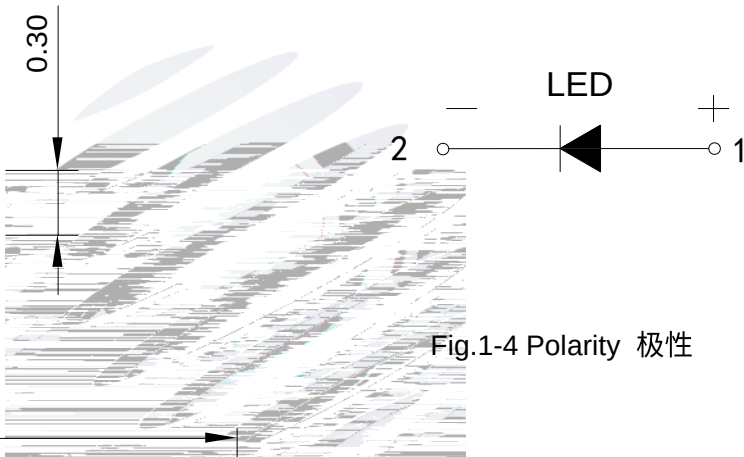


Fig.1-4 Polarity 极性

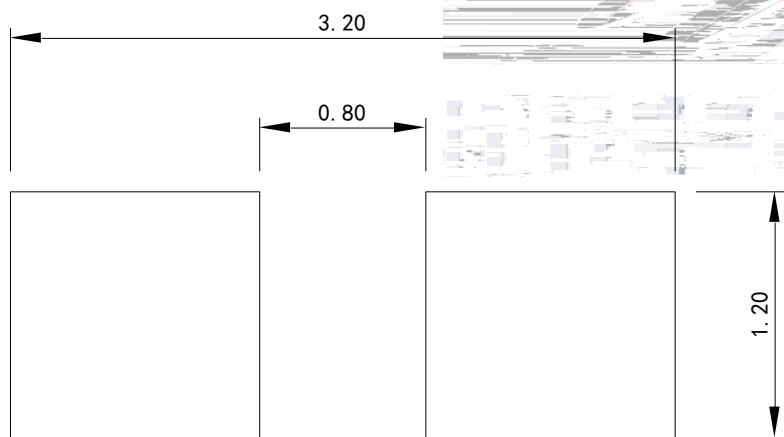


Fig.1-5 Soldering patterns 推荐焊盘

Notes 备注:

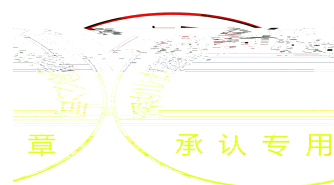
1. All dimensions units are millimeters. 所有尺寸标注单位为毫米
2. All dimensions tolerances are $\pm 0.2\text{mm}$ unless otherwise noted. 除特别标注外, 所有尺寸公差为 ± 0.2 毫米

1.5 Product Parameters 产品参数

Table 1-1 Electrical / Optical Characteristics at Ts=25°C 电性与光学特性

Item 项目	Test Condition 测试条件	Symbol 符号		Value			Unit 单位
				Min. (最小值)	Typ. (典型值)	Max. (最大值)	
Forward Voltage 正向电压	I _F =20mA	V _F	F1	2.6	--	2.7	V
			F2	2.7	--	2.8	V
			G1	2.8	--	2.9	V
			G2	2.9	--	3.0	V
			H1	3.0	--	3.1	V
			H2	3.1	--	3.2	V
			I1	3.2	--	3.3	V
			I2	3.3	--	3.4	V
Luminous Intensity 发光强度	I _F =20mA	I _v	J1	3.4	--	3.5	V
			1BB	400	--	450	mcd
			1BC	450	--	500	mcd
			1BD	500	--	550	mcd
			1BE	550	--	600	mcd
			1BF	600	--	650	mcd
			1BG	650	--	700	mcd
			1BH	700	--	750	mcd
			1BI	750	--	800	mcd
			1BJ	800	--	850	mcd
			1BK	850	--	900	

Notes 备注: V_R=5V For test conditions. V_R=5V 为测试分选条件。



1.6 Bin Range Of Forward Voltage and Luminous Flux (IF=20mA)电压与流明分 BIN 范围(IF=20mA)

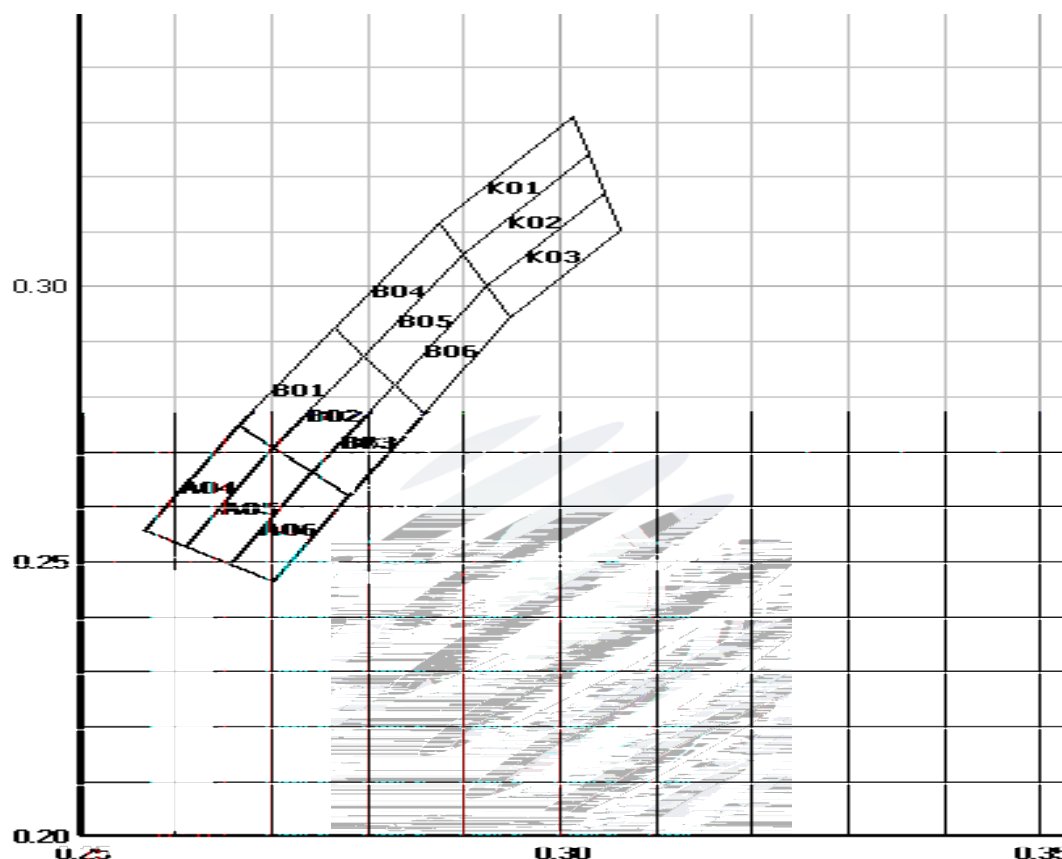


Fig. 1-6 The C.I.E Chromaticity Diagram CIE色度图

Table 1-3 Bin Date Bin数据

BIN CODE	CIE-X1	CIE-Y1	CIE-X2	CIE-Y2	CIE-X3	CIE-Y3	CIE-X4	CIE-Y4
B01	0.2700	0.2705	0.2663	0.2746	0.2764	0.2923	0.2794	0.2872
B02	0.2741	0.2660	0.2700	0.2705	0.2794	0.2872	0.2826	0.2819
B03	0.2779	0.2618	0.2741	0.2660	0.2826	0.2819	0.2856	0.2767
B04	0.2794	0.2872	0.2764	0.2923	0.2874	0.3114	0.2898	0.3056
B05	0.2826	0.2819	0.2794	0.2872	0.2898	0.3056	0.2923	0.2999
B06	0.2856	0.2767	0.2826	0.2819	0.2923	0.2999	0.2947	0.2942
K01	0.2898	0.3056	0.2874	0.3114	0.3013	0.3309	0.3029	0.3240
K02	0.2923	0.2999	0.2898	0.3056	0.3029	0.3240	0.3045	0.3170
K03	0.2947	0.2942	0.2923	0.2999	0.3045	0.3170	0.3061	0.3101
A04	0.2608	0.2525	0.2566	0.2555	0.2663	0.2746	0.2700	0.2705
A05	0.2655	0.2492	0.2608	0.2525	0.2700	0.2705	0.2741	0.2660
A06	0.2699	0.2461	0.2655	0.2492	0.2741	0.2660	0.2779	0.2618

1.7 Typical Optical Characteristics Curves 典型光学特性曲线

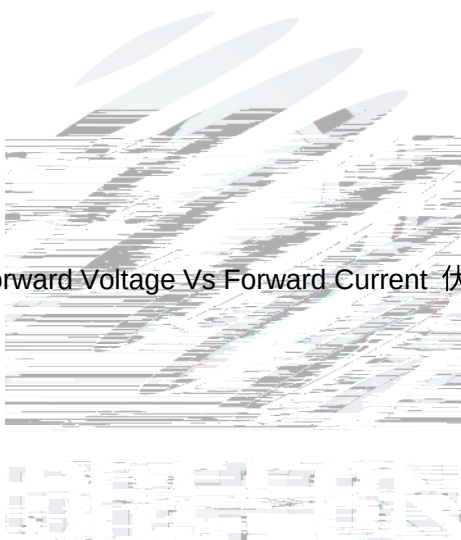


Fig 1-8 Forward Voltage Vs Forward Current 伏安特性曲线

Fig 1-9 Forward Current Vs Relative Intensity

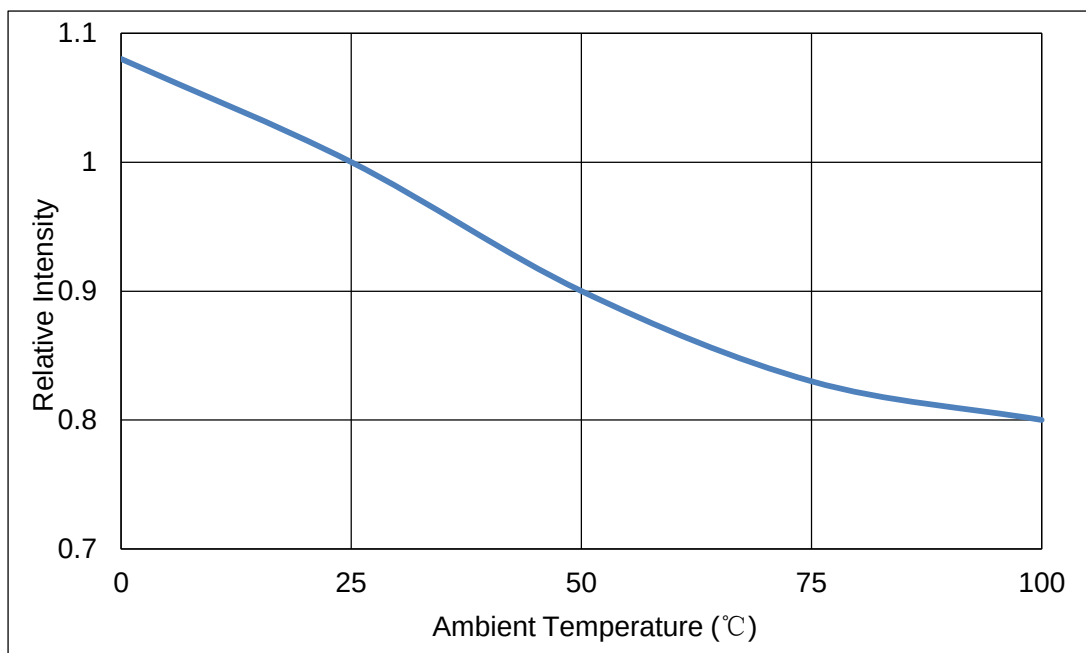


Fig 1-10 Pin Temperature Vs Relative Intensity 引脚温度与相对光强特性曲线

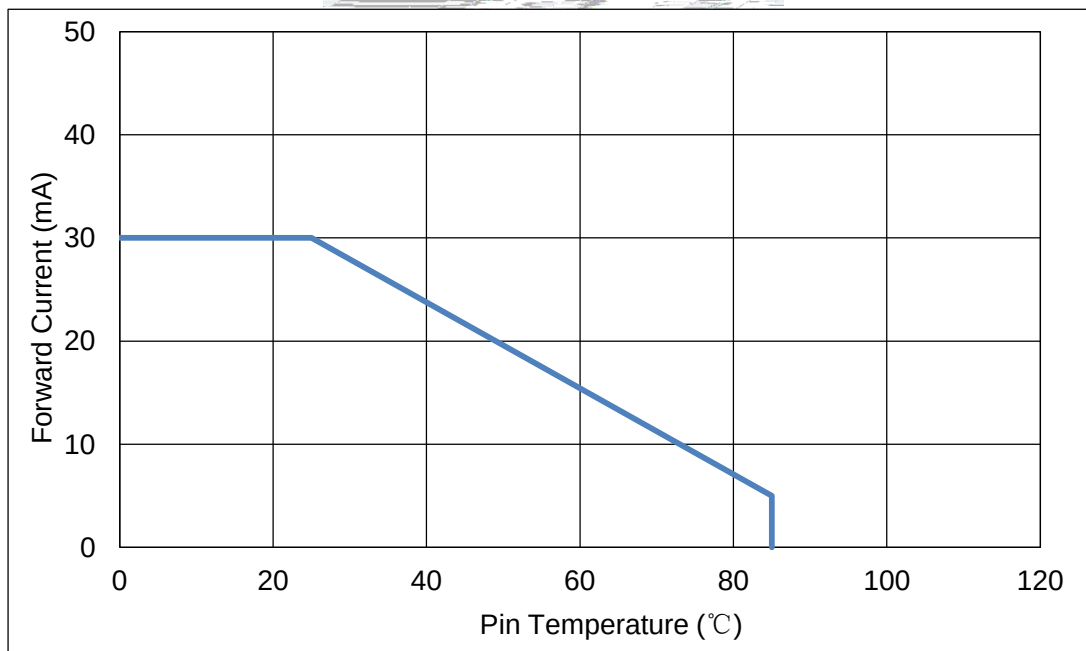
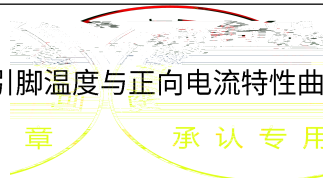


Fig 1-11 Pin Temperature Vs Forward Current 引脚温度与正向电流特性曲线



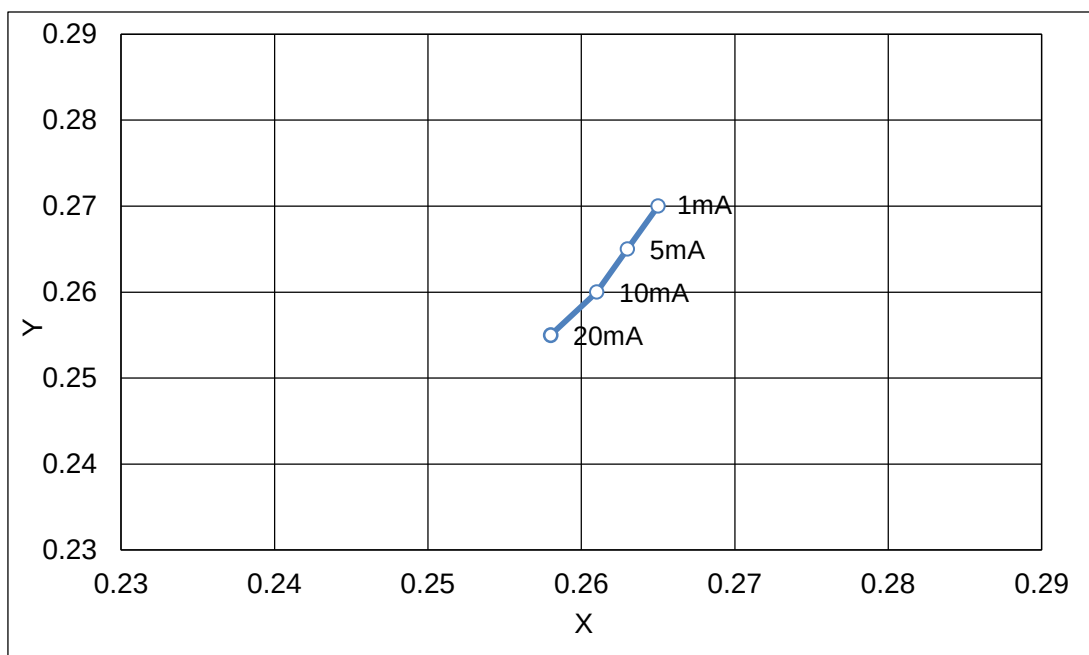


Fig.1-12 Forward Current Vs Dominate Wavelength (Ta=25°C) 正向电流与主波长关系曲线

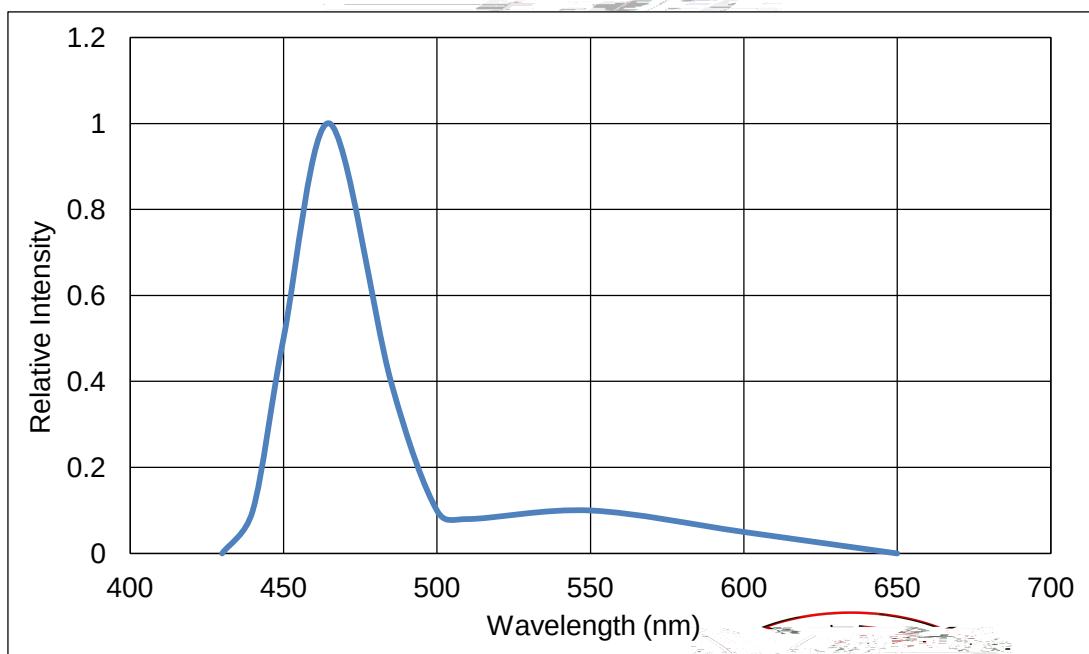


Fig.1-13 Relative Intensity Vs Wavelength (Ta=25°C) 相对光强与波长关系曲线

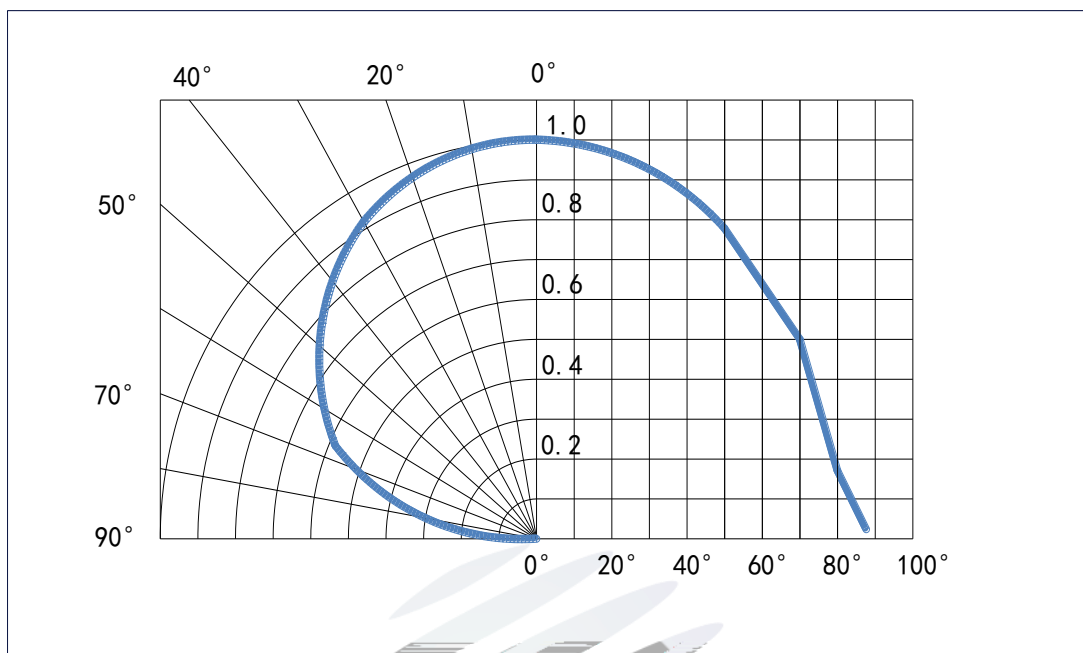
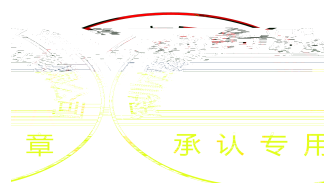
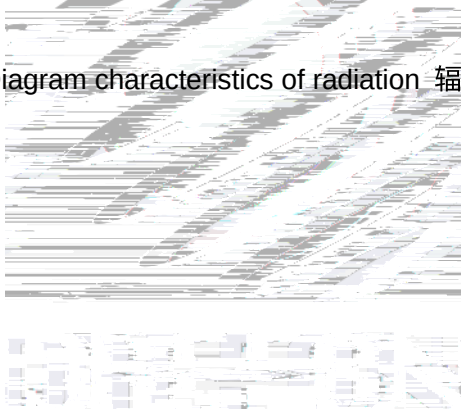


Fig.1-14 Diagram characteristics of radiation 辐射特性曲线



2. Packaging 产品包装

2.1 Packaging Specification 包装规格

Package:4000pcs/reel.包装每卷 4000pcs。

2.1.1 Carrier Tape Dimension 载带尺寸

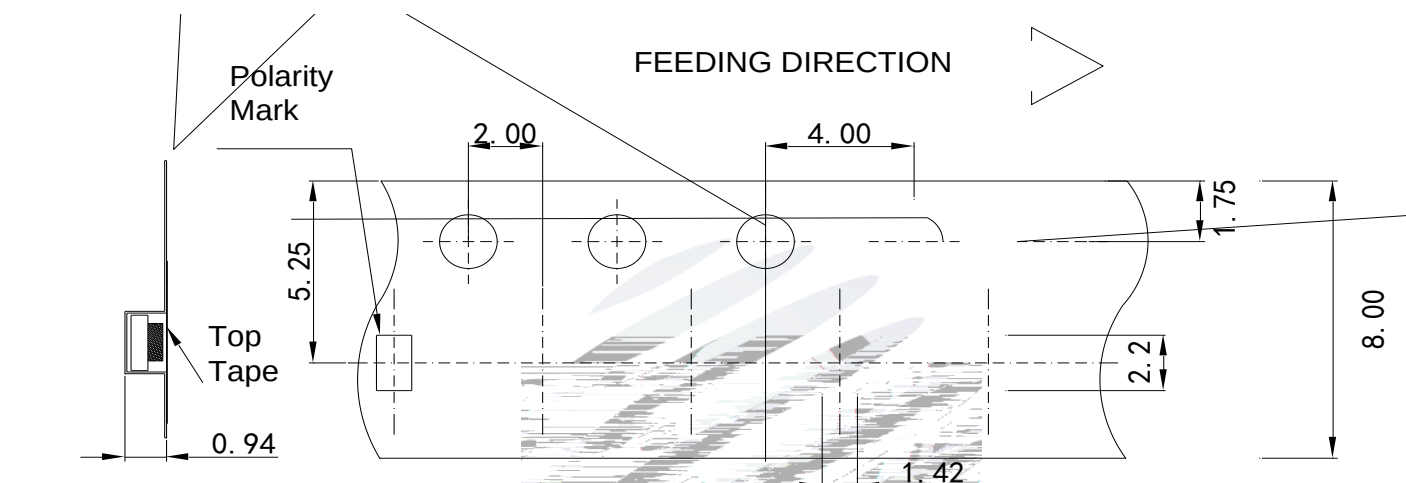


Fig.2-1 Carrier Tape Dimension 载带尺寸

2.1.2 Reel Dimension 卷盘尺寸

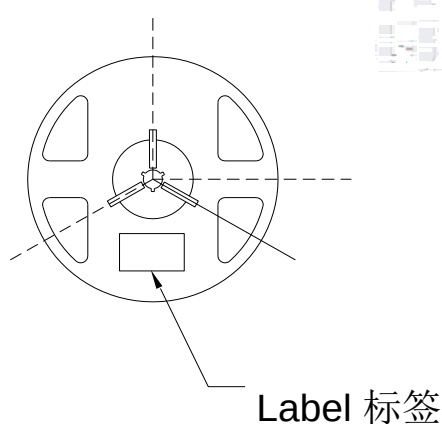


Fig.2-2 Reel Dimension 卷盘尺寸

Table 2-1 Dimension 尺寸

A	$8.0 \pm 0.1 \text{mm}$
B	$178 \pm 1 \text{mm}$
C	$60 \pm 1 \text{mm}$
D	$13.0 \pm 0.5 \text{mm}$

Notes 备注:

The tolerances unless mentioned $\pm 0.1 \text{mm}$. Unit : mm 注：未注公差为 ± 0.1 毫米，尺寸单位：毫米。

2.1.3 Label Form Specification 标签规格

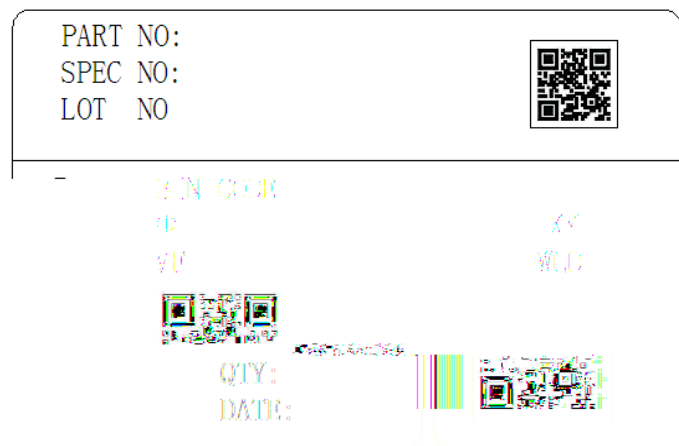


Table 2-2 Parameter 参数

PART NO.	Part Number 品名
SPEC NO.	Spec Number 规格
LOT NO.	Lot Number 批次号
BIN CODE	Bin Code 参数代码
Φ	Luminous flux 光通量
XY	Chromaticity Bin 色区
V _F	Forward Voltage 正向电压
WLD	Wavelength 波长代码
QTY	Packing Quantity 数量
DATE	Made Date 生产日期

Fig. 2-3 Label Form Specification 标签规格

2.2 Moisture Resistant Packing 防潮包装

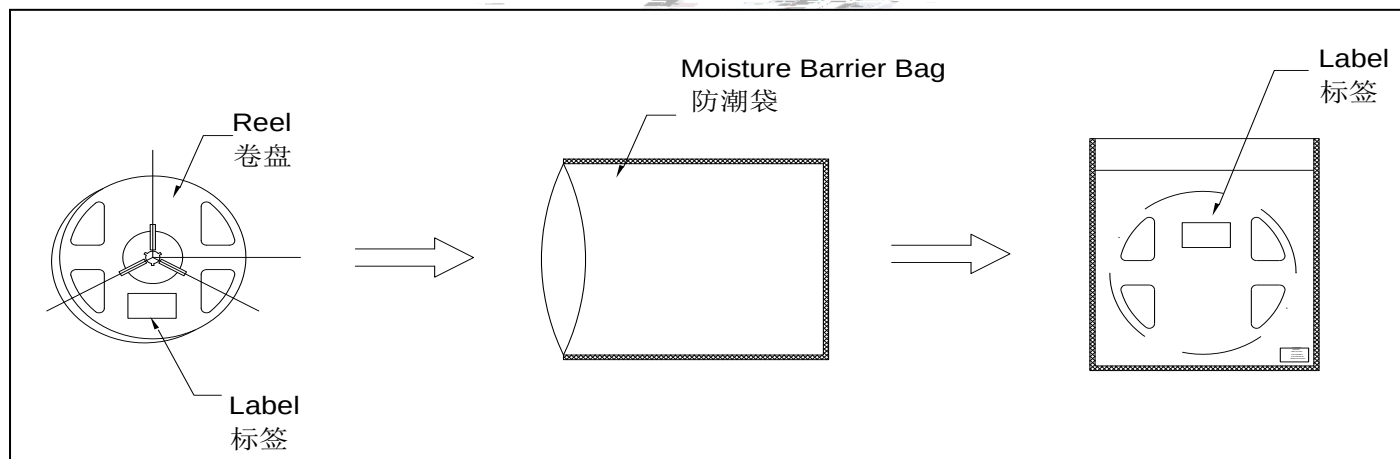
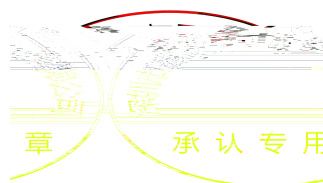


Fig.2-4 Moisture Resistant Packing 防潮包装



2.3 Cardboard Box 包装纸箱

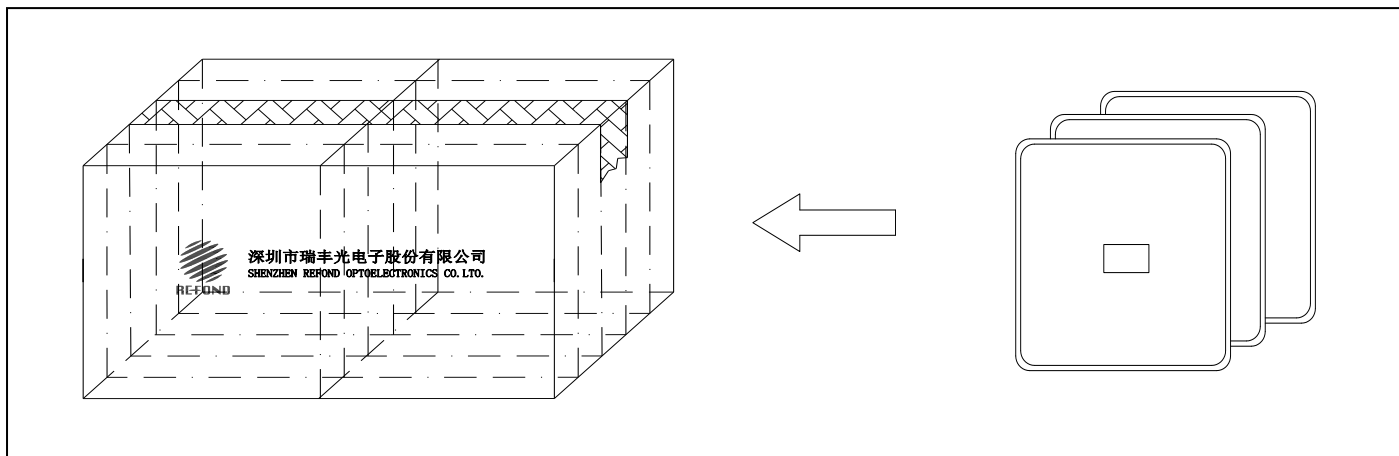


Fig.2-5 Cardboard Box 包装纸箱

2.4 Reliability Test Items And Conditions 信赖性测试项目及条件

Table 2-3 Reliability Test Items And Conditions 信赖性测试项目及条件

Test Items 项目	Ref.Standard 参考标准	Test Condition 测试条件	Time 时间	Quantity 数量	Ac/Re 接收/拒收
Reflow 回流焊	JESD22-B106	Temp:260°Cmax T=10 sec	2 times	22Pcs.	0/1
Temperature Cycle 温度循环	JESD22-A104	100°C 30 min ↑↓5 min -40°C 30 min	100 cycles	22Pcs.	0/1
Thermal Shock 冷热冲击	JESD22-A106	-40°C 15min ↑↓ 100°C 15min	300 cycles	22Pcs.	0/1
High Temperature Storage 高温保存	JESD22-A103	Temp:100°C	1000 hrs.	22Pcs.	0/1
Low Temperature Storage 低温保存	JESD22-A119	Temp:-40°C	1000 hrs.	22Pcs.	0/1
Life Test 常温通电	JESD22-A108	T _a =25°C I _F =20mA	1000 hrs.	22Pcs.	0/1

2.5 Criteria For Judging Damage 失效判定标准

Table 2-4 Criteria For Judging Damage 失效判定标准

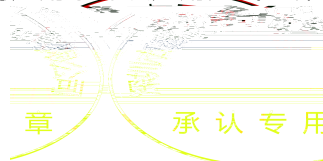
Test Items 项目	Symbol 符号	Test Condition 测试条件	Criteria For Judgement 判定标准	
			Min. 最小	Max. 最大
Forward Voltage 正向电压	V_F	$I_F=20mA$	-	$U.S.L^*) \times 1.1$
Reverse Current 漏电流	I_R	$V_R=5V$	-	$U.S.L^*) \times 2.0$
Luminous Flux 光通量	Φ	$I_F=20mA$	$L.S.L^*) \times 0.7$	-

Notes 备注:

1.U.S.L: Upper standard level 规格上限 L.S.L: Lower standard level 规格下限

2.The above reliability tests is based on the verification of a single/strip LED of Refond's existing experimental platform,the reliability experiment was taken under good heat dissipation conditions. When customers applies the LED to the series and parallel circuit,should take consideration of all the factors such as the current, voltage distribution, heat dissipation and others. 以上可靠性测试是基于瑞丰现有实验平台单颗/条 LED 在良好散热条件验证下的结果。客户端将 LED 应用于串、并联线路时，需自行评估电流、电压分配、散热等问题。

3.The technical information shown in the data sheets is limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license. 以上技术数据仅为产品的典型值，只作为参考，不作为任何应用条件及应用方式的保证。



3. SMT Reflow Soldering Instructions SMT 回流焊说明

3.1 SMT Reflow Soldering Instructions SMT 回流焊说明

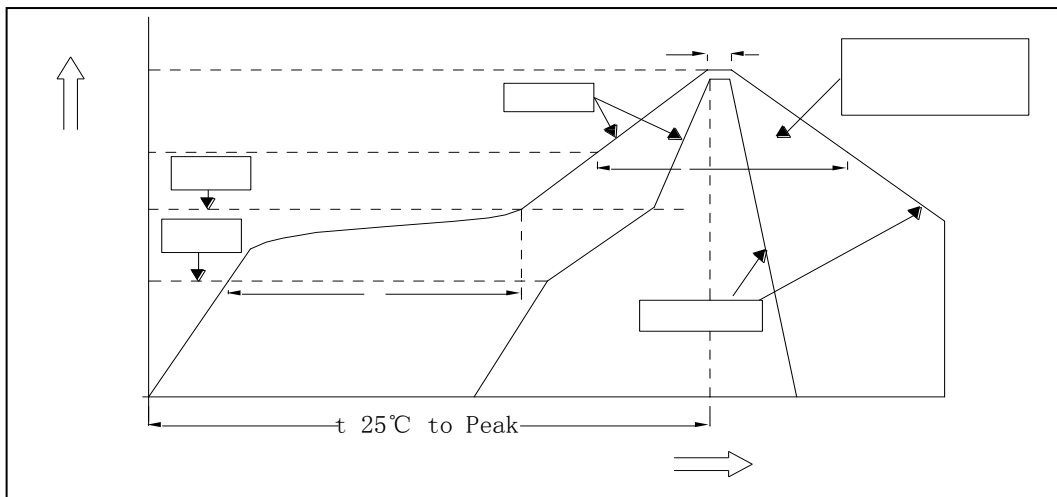
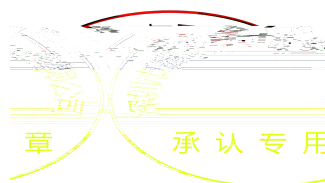


Fig.3-1 SMT Reflow Soldering Instructions SMT 回流焊说明

Table 3-1 Parameter 参数

Average temperature rise speed平均升温速度 (T _{max} 至 T _P)	最高3 °C/秒 Max 3 °C/ s
Preheating: minimum temperature预热: 最低温度 (T _{min})	150 °C
Preheating: Max temperature预热: 最高温度 (T _{max})	200 °C
Preheating: Time预热: 时间 (T _{min} 至 T _{max})	60 - 120秒 60s-120s
Time limited to maintain high temperature: the temperature限时维持高温: 温度(T _L)	217 °C
Time limited to maintain high temperature: The Time 限时维持高温: 时间 (t _L)	最多60秒 Max 60s
Peak /Classification of temperature:峰值 / 分类温度 (T _P)	260 °C
Time limit classification of peak temperature time限时峰值分类温度: 时间 (t _p)	最多10秒 Max 10s
Hold time within 5 °C with the actual peak temperature (T _P) 与实际峰值温度 (T _P) 相差 5 °C 以内的保持时间	最多30秒 Max 30s
Cooling speed 降温速度	最高6 °C/秒 Max 6 °C/ s
Needed time from 25 °C to T _p 25 °C 升至峰值温度所需时间	最多8分钟 Max 8 minutes



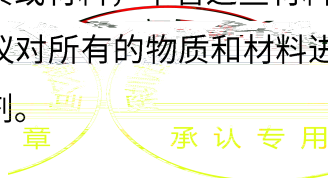
4. Handling Precautions 产品使用注意事项

4.1 Handling Precautions 产品使用注意事项

(1) LED operating environment and sulfur element composition cannot be over 100PPM in the LED mating usage material. This is provided for informational purposes only and is not a warranty or endorsement. LED 工作环境及与 LED 适配的材料中硫元素及化合物成份不可超过 100PPM. 这只是一个建议，不作任何品质担保。

(2) In order to prevent external material from getting into the inside of LED, which may cause the malfunction of LED, the single content of Bromine element is required to be less than 900PPM, the single content of Chlorine element is required to be less than 900PPM, the total content of Bromine element and Chlorine element in the external materials of the application products is required to be less than 1500PPM. This is provided for informational purposes only and is not a warranty or endorsement. 为了防止外界物质进入 LED 内部以造成 LED 的损伤，所处环境及所用套件等等，单一的溴元素含量要求小于 900PPM，单一氯元素含量要求小于 900PPM，溴元素与氯元素总含量必须小于 1500PPM. 这只是一个建议，不作任何品质担保。

(3) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues. Refond advises against the use of any chemicals or materials that have been found or are suspected to have an adverse effect on device performance or reliability. To verify compatibility, Refond recommends that all chemicals and materials be tested in the specific application and environment for which they are intended to be used. Attaching LEDs, do not use adhesives that outgas organic vapor. 应用套件中的挥发性物质会渗透到 LED 内部，在通电产生光子及热的条件下，会导致 LED 变色，进而造成严重光衰，提前了解套件材料能够避免产生这些问题。瑞丰反对使用任何对 LED 器件的性能或者可靠性有害的物质或材料，不管这些材料是已经证实了的还是仅仅怀疑有害。针对特定的用途和使用环境，瑞丰建议对所有的物质和材料进行相容性的测试。在贴装 LED 时候，不要使用能产生有机挥发性气体的粘结剂。



(4) In designing a circuit,the current through each LED can not exceed the absolute maximum rating specified for each LED.In the meanwhile,resistors for protection should be applied,otherwise slight voltage shift will cause big current change,burn out may happen. The driving circuit must be designed to allow forward voltage only when it is ON or OFF.If the reverse voltage is applied to LED, migration can be generated resulting in LED damage. 设计电路时，通过 LED 的电流不能超过规定的最大值。同时，还需使用保护电阻，否则，微小的电压变化将会引起较大电流变化，可能导致产品损毁。电路设计必须保证只有在开关处于导通的时候出现正向电压的变化，不要施加反压，否则会损坏 LED。

(5) Thermal Design is paramount importance because heat generation may result in the Characteristics decline,such as brightness decreased,Color change and so on.Please consider the heat generation of the LEDs when making the system design.LED 容易因为自身的发热和环境的温度改变而改变，温度升高会降低 LED 发光效率，影响发光颜色，所以在设计时应充分考虑散热问题。

(6) Storage 储存

Table 4-1 Storage 储存

Conditions 种类		Temperature 温度	Humidity 湿度	Time 时间
Storage 储存	Before Opening Aluminum Bag 拆包前	$\leq 30^{\circ}\text{C}$	$\leq 75\%$	Within 1 Year From Date 一年内
	After Opening Aluminum Bag 拆包后	$\leq 30^{\circ}\text{C}$	$\leq 60\%$	168hours 168小时
Baking 烘烤		$60 \pm 5^{\circ}\text{C}$	-	$\geq 24\text{hours}$ 大于24小时

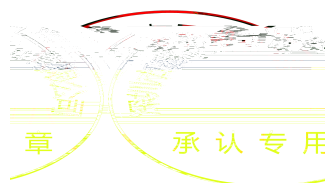
(7) If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time , baking treatment should be performed after unpacking and based on the following condition (60 ± 5) $^{\circ}\text{C}$ for above 24 hours.如果干燥剂或包装失效，或者产品不符合以上有效储存条件，需拆包后进行烘烤，烘烤条件： $60 \pm 5^{\circ}\text{C}$ 大于24 小时。

If the package is flatulence or damaged,please notify the sales staff to assist.如果包装胀气或者破损，请及时与销售人员联系处理。

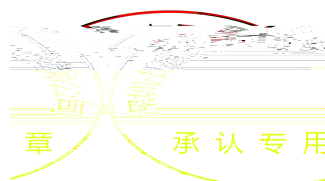


(8) Similar to most Solid state devices; LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS). 像其他的半导体电子器件一样，LED 对静电过流击穿非常敏感，需要做好防护。

(9) Other points for attention, please refer to our relevant information. 其它注意事项请参照瑞丰相关资料。



[illegible]



Declare 申明

This specification is written both in English and in Chinese and the latter is formal.

产品规格书以中英文方式书写，若有冲突以中文版本为准。